

KSTAR TF / Soldering Technique for the Horizontal / Vertical Installation of TF coil joints in the KSTAR Device

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150

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(KSTAR)

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(lap)

(sleeve)

(furnace)

가

(mold)

, 70

가

(wetting)

가

Abstract

The soldering process for horizontal and vertical installation of strand-to-strand joint which was suggested using in KSTAR device was investigated. In case of conventional soldering using a heat blower, the infiltration of solder into cable was not sufficient to fill the joint, and the flow-down of molten solder due to its weight was observed. The mold assembly for soldering strand-to-strand joint was designed and fabricated using the concept of the sleeve of lap joint. Small furnace was installed in the mold to heat the joint uniformly, and two hole-lines with 70-air holes each for solidify the molten solder were machined to prevent the leakage of solder out of the joint. The solidification line of solder along the first hole-line in the mold was observed. The wetting property in the cable may be improved because the cable was compacted by the mold, and the infiltration of solder into the cable was sufficient to fill the joint.

1.

(KSTAR : Korea Superconducting Tokamak Advanced Research)

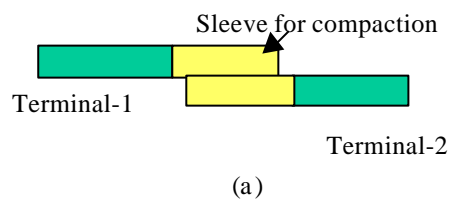
가 TF (Toroidal Field) PF
 (Poloidal Field) TF 16
 3.5T, 7.5T TF CICC
 (Cable in Conduit Conductor) 2.8 mm Incoloy (conduit) 486
 Nb₃Sn (strand) (twisting)
 35.2 KA 가 , 16 TF

[1].

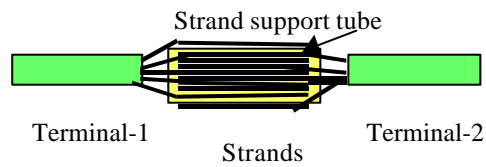
1(a)

. KSTAR

1(b) - (strand-to-strand) 가 [2].



(a)



(b)

Fig. 1. Schematic drawing of (a) Lap joint and (b) Strand-to-Strand joint

(void volume)

가 가

가

KSTAR

TF

가

가

가

2. -

가

가

가

가

joule

가

가

(current sharing temperature)

[3].

가

가

가

54

1.8 K

0.4 n-ohm

486

0.1~1 n-ohm

[2].

가

3. /

1(a)

가

1(b)

[4].

가

가

가

가

1.5 mm

70

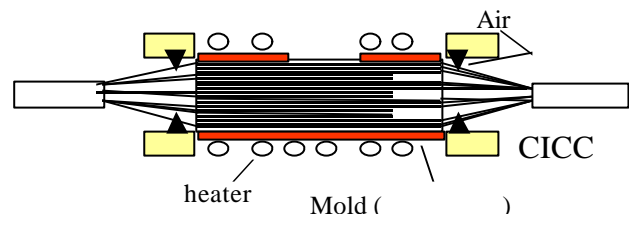


Fig. 2. Schematic drawing of mold assembly for strand-to-strand joint

4.

가 CICC . 486 3x3x3x3x6
 , (wrapping) , 30.2
 34 mm 316L
 mm , 25.8 mm (void volume fraction) 52 % CICC
 CICC 25 cm , 3
 (triplet)
 3 (slot)
 [5].
 3
 40 3 4
 4
 (band)
 10 cm , 65 mm

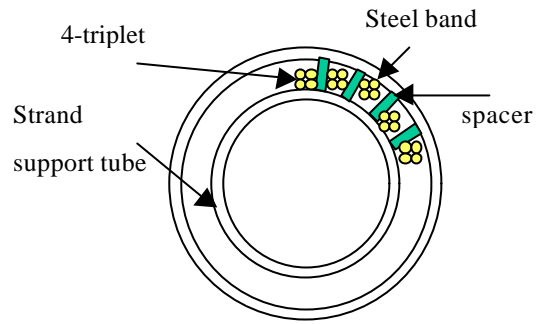


Fig. 3. Schematic drawing of cross-section of strand-to-strand joint

1.4 KW

가

4 가

40Pb60Sn 1 kg

1.2 KW 1.0 가

가

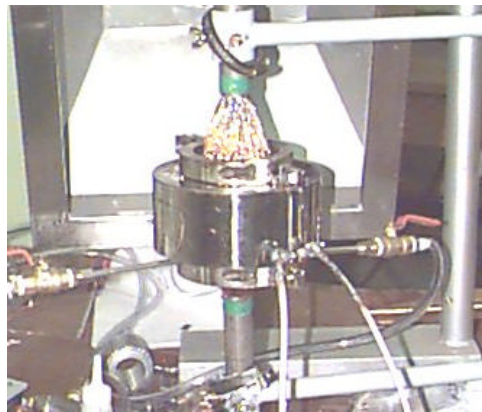


Fig. 4. Mold assembly for soldering vertical joint

5.

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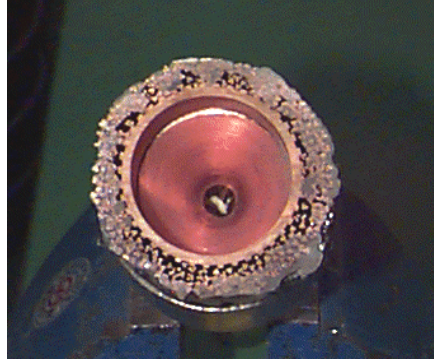


Fig. 5. Cross-section of the joint soldered with heat blower without mold

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6

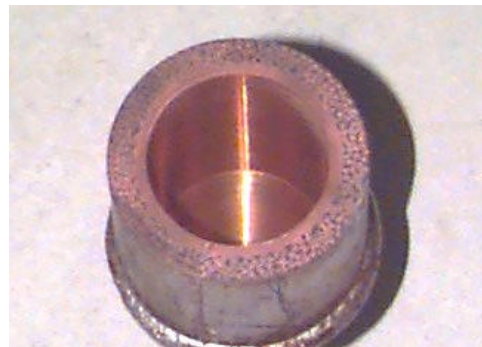


Fig. 6. Cross-section of the joint soldered with mold

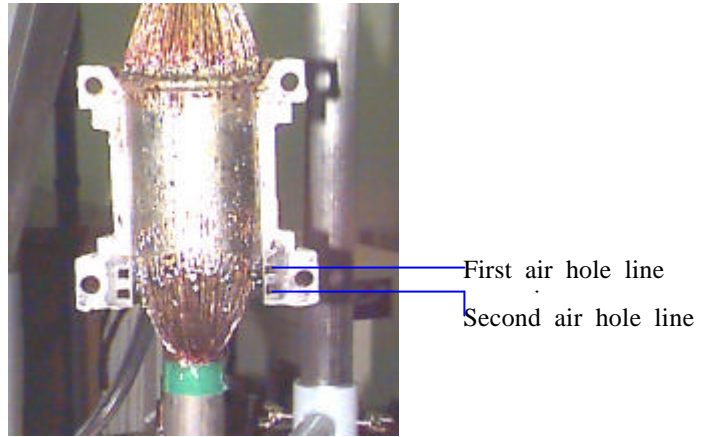


Fig. 7. Side view of soldered vertical joint

6.

KSTAR

TF

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가 가

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T13&14-3 ~ T13\$14-19, August 1999

2. Shahin Pourrahimi et al., Fabrication of 40 kA Superconducting Sample-Under-Test for Samsung, MIT PSFC final report, 1998

3. P. Bruzzone et al., " Design and R&D Results of the Joint for the ITER Conductor" IEEE Transactions on Applied Superconductivity, Vol.7, No.2, pp461-464, 1997

4. Dave Smith, Welding Skills and Technology, Gregg Division/Mcgraw-Hill, pp151-167, 1984

5. , " - "

- 1 , 1998